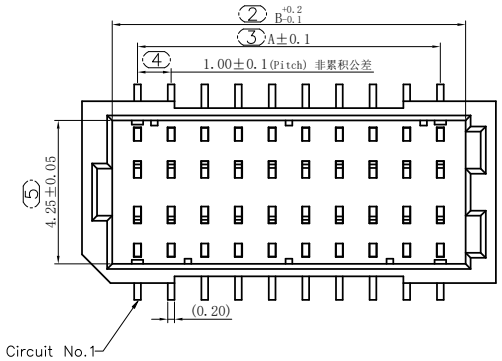
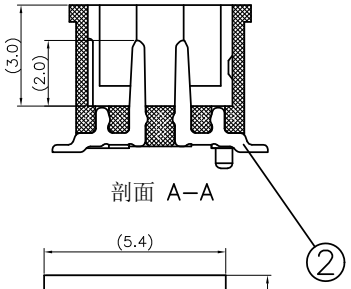
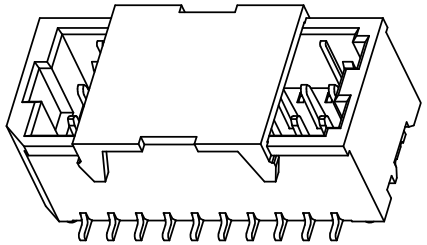
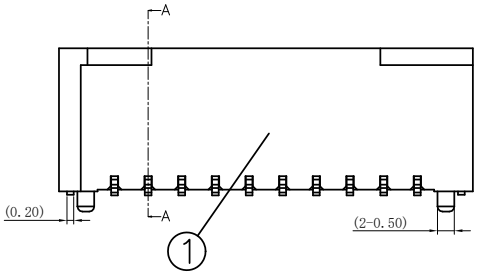
| REV. | DESCRIPTION | DATE |
|---|---|---|
| A/0 | 新版发行 | 2017.03.20 |
| | | |
| | | |

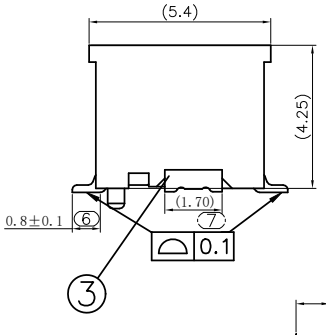


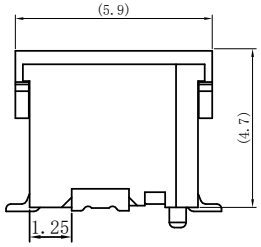




剖面 A-A



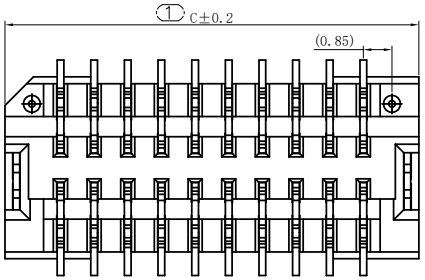


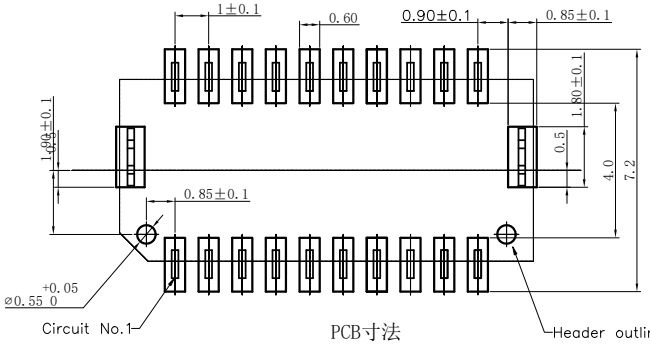




NOTES:
1. MATERIAL SEE TABLE;
2. PLATING SEE TABLE;
3. RATING
3-1. OPERATING TENPERATURE:-25~85°C
3-2. OPERATING VOLTAGE: 50V AC/DC
3-3. CURRENT RATING: 1AMPS(28#)
3-4. DIELECTRIC WITHSTANGING VILTAGE: 500V AC/Minute;
3-5. INSULATION RESISTANCE:100MΩ Min;
3-6. CONTACT RESISTANCE:0.03Ω Max;
4. PART NO.

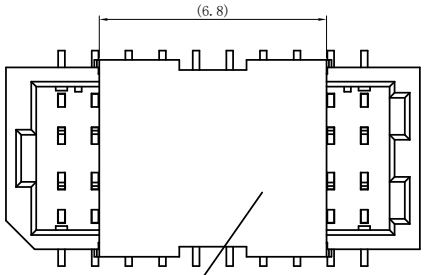
61015-**03-2001
SERIES
CIRCUIT NO
Packing Option: 0=Reel Packing
Lead Free & HF 2=Lead Free
Plating: 3=Gold Flash OVER Ni 30μ"Min..




PCB寸法

| 孔位 poles | A | B | C |
|---|---|---|---|
| 12 | 5 | 6.5 | 8.3 |
| 14 | 6 | 7.5 | 9.3 |
| 16 | 7 | 8.5 | 10.3 |
| 20 | 9 | 10.5 | 12.3 |
| 22 | 10 | 11.5 | 13.3 |
| 30 | 14 | 15.5 | 17.3 |
| 40 | 19 | 20.5 | 22.3 |
| 50 | 24 | 25.5 | 27.3 |




SHD-2*nAB 适合CAP
编带专用

| 序号 | 图号 | 名称 | 材料 | 数量 | 附注 |
|---|---|---|---|---|---|
| 4 | 152-1015-001 | 盖子 CAP | PA9T(UL94V-0) | 1 | 本色 |
| 3 | 122-1015-001 | 焊片Fitting Nail | 磷青铜Phosphor Bronze | 2 | 电镀: 整个表面镀底镍30u"MIN,再镀金Gold Flash. |
| 2 | 112-1015-001 | 端子 Contact | 磷青铜Phosphor Bronze | n×1 | 电镀: 整个表面镀底镍30u"MIN,再镀金Gold Flash. |
| 1 | 132-1015-002 | 基座 Wafer | PA9T(UL94V-0) | 1 | 本色 |

| GENERAL TOLERANCES | | | DRAWN BY | 赵婷婷/2017.03.20 | 新富尔电子有限公司 XINFUER ELECTORN CO.,LTD |
|---|---|---|---|---|---|
| 0.X ±0.25 | X.° ±3° | | CHK. BY | 崔华文/2017.03.20 | |
| 0.XX ±0.12 | | | APRV. BY | 洪新江/2017.03.20 | SHEET 1 OF 1 / PROD. NAME SHD-2*nABS |
| 0.XXX ±0.05 | X.X° ±0.5° | | | | PART NO. 61015-**03-2001 |
| UNIT MM / SIZE A4 / SCALE 1:1 | | | DRAWING NO. 006-1015-002 | | TITLE 1.0 WTB CONN. SMT SINGLE ROW VERTICAL |

借用登记
旧底图总号
底图总号
签 字
日 期